ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoc international and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	is document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly hower level parts, the declaration encompasses all lower level materials for which the manufacturer has gineering responsibility.  Adobe Reader version 7.0.5 is required to complete this declaration.										
1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x						Form Type * Declaration Class * Distribute Class 6 - RoHS Yes/No, Homogeneous Mater						Materials	s and Mfg Informa		
Supplier Information																
Company Name *		Company Unique ID		Unique ID Au	nique ID Authority		Response Date *			Response Document ID						
SEMTECH CORPORATION		00-847-9941		DUNS		2016-05-25										
Contact Name *		Title - Contact		Phone - Con	tact *	Email	- Contac	t *		D II		A 41-	: I D			
Roya Motamedi		Supervisor, QA Prod	uct Suppo	805-498-2111		rmotamedi@semtech.com			om	Duplica	ate Contact	-> Autno	orizea Re	epresentative		
Authorized Representative *		Title - Representative	9	Phone - Representative *		Email - Representative *			S	Supplier Comments or URL for Additional Information						
Roya Motamedi		Supervisor, QA Prod	luct Suppo	805-498-2111		rmotamedi@semtech.com			om							
Requester Item Number		Mfr Item Number		Mfr Item Name		Effective Date Versi		Version	Manufac	turing Site	Weight *	U	MC	Unit Type		
		UClamp0506T.TCT		Low Profile µClamp® 6-Line ES		3		C	China		2.07	m	g g	Each		
Alternate Recommend	ation	n					Alternate Item C		tem Con	nments		•				
Manufacturing Proces	ss In	formation														
Ferminal Plating / Grid Array Material			Terminal B	I Base Alloy J-STD-020 MSL		ating Peak Process Body Ten		Temperat	ure Max Tin	ne at Peak Ter	mperature	Number	of Reflow Cycles			
Nickel/Palladium/Gold (Ni/Pd/Au)			CU Alloy	y  1			260		<b>60</b> C	<b>30</b> so		seconds	econds 3			
Comments					1	!				1			ļ			
UClamp0506T.TCT is RE	ACH	-compliant product,	per EU R	egulation EC	1907/2006 to incl	ude re	cent addi	tion of S	VHC ca	ndidate list	t of substan	ces in De	ecember	2015.		

Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type \*** Detailed Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a ?RoHS restricted substance?) in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier?s liability and the Company?s remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. 1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance \* Accepted **RoHS Declaration \*** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. **Declaration Signature** 

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## **Homogeneous Material Composition Declaration for Electronic Products**

**Subltem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

е	Leve		aory		Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
		I Substance Cate	gory		Substance	UA3				-	+	
+C -C	Supp	ier	+S	-\$	Si	7440-21-3		0.0288	mg			13,912
+C -C	Supp	ier	+S	Ş	Cu	7440-50-8		0.8247	mg			398,36
			+S	-s	Si	7440-21-3		0.0062	mg			3,012
+C -C	СВ	Nickel (external a	applic +S	-s	Nickel	7440-02-0		0.0275	mg			13,293
+C -C	CSupp	ier	+S	-s	Mg	7439-95-4		0.0015	mg			727
+C -C	СВ		+S	-S	Nickel	7440-02-0		0.0199	mg			9,604
+C -C	CSupp	ier middle plating	+S	-s	Pd	7440-05-3		0.0018	mg			873
+C -C	CSupp	ier outer plating	+S	-s	Au	7440-57-5		0.0004	mg			174
+C -C	Supp	ier	+S	-S	Silica fused	60676-86-0		1.0463	mg			505,41
			+S	-s	Epoxy resin	Proprietary		0.0336	mg			16,216
			+S	-s	Phenol resin	Proprietary		0.0336	mg			16,216
			+S	-s	Carbon Black	1333-86-4		0.0056	mg			2,703
+C -C	Supp	ier	+S	-S	Ag	7440-22-4		0.0127	mg			6,142
	•	•	+S	-s	Palladium compound	Proprietary		0	mg			12
			+S	-s	2,6-Di-tert-butyl-p-creso	128-37-0		0	mg			0.383
			+S	-s	Hydroquinone	123-31-9		0	mg			0.005
			+S	-s	Acrylate	Proprietary		0.0025	mg			1,216
			+S	-s	Bismaleimide resin	Proprietary		0.005	mg			230
			+S	-s	Polymer of polybutadie	Proprietary		0.0002	mg			77
	+C -( +C -( +C -( +C -(	+C -C Suppl	+C -C Supplier  +C -C B Nickel (external at the content of the con	+C -C Supplier +S  +C -C B Nickel (external applic +S  +C -C Supplier +S  +C -C Supplier middle plating +S  +C -C Supplier outer plating +S  +C -C Supplier +S  +C -C Supplier +S  +C -C Supplier +S  +S  +S  +S  +S  +S  +S  +S  +S  +S	+C -C Supplier +S -S +S -S +S -S +C -C B Nickel (external applic +S -S +C -C Supplier +S -S +S -S +C -C Supplier middle plating +S -S +C -C Supplier outer plating +S -S +C -C Supplier outer plating +S -S	+C -C Supplier +S -S Cu +S -S Si  +C -C B Nickel (external applic +S -S Nickel +C -C Supplier +S -S Mg +C -C B +S -S Nickel +C -C B +S -S Nickel +C -C Supplier middle plating +S -S Nickel +C -C Supplier outer plating +S -S Au +C -C Supplier Supplier +S -S Silica fused +S -S Epoxy resin +S -S Epoxy resin +S -S Carbon Black +C -C Supplier +S -S Ag +S -S Palladium compound +S -S 2,6-Di-tert-butyl-p-creso +S -S Hydroquinone +S -S Acrylate +S -S Bismaleimide resin	+C -C Supplier +S -S Cu 7440-50-8  +S -S Si 7440-21-3  +C -C B Nickel (external applic +S -S Nickel 7440-02-0  +C -C Supplier +S -S Mg 7439-95-4  +C -C B +S -S Nickel 7440-02-0  +C -C Supplier middle plating +S -S Pd 7440-05-3  +C -C Supplier outer plating +S -S Au 7440-57-5  +C -C Supplier +S -S Silica fused 60676-86-0  +S -S Epoxy resin Proprietary  +S -S Carbon Black 1333-86-4  +C -C Supplier +S -S Ag 7440-22-4  +S -S Palladium compound Proprietary  +S -S Hydroquinone 123-31-9  +S -S Acrylate Proprietary	+C -C Supplier +S -S Cu 7440-50-8  +C -C B Nickel (external applic +S -S Nickel 7440-02-0  +C -C Supplier +S -S Mg 7439-95-4  +C -C B Nickel PA40-02-0  +C -C Supplier Niddle plating +S -S Nickel 7440-02-0  +C -C Supplier Niddle plating +S -S Pd 7440-05-3  +C -C Supplier Outer plating +S -S Au 7440-57-5  +C -C Supplier Supplier PS -S Silica fused 60676-86-0  +S -S Epoxy resin Proprietary +S -S Carbon Black 1333-86-4  +C -C Supplier PROPRIET	+C -C Supplier +S -S Cu 7440-50-8 0.8247  +S -S Si 7440-21-3 0.0062  +C -C B Nickel (external applic +S -S Nickel 7440-02-0 0.0275  +C -C Supplier +S -S Mg 7439-95-4 0.0015  +C -C B +S -S Nickel 7440-02-0 0.0199  +C -C Supplier middle plating +S -S Pd 7440-02-0 0.0199  +C -C Supplier outer plating +S -S Au 7440-57-5 0.0004  +C -C Supplier outer plating +S -S Silica fused 60676-86-0 1.0463  +S -S Epoxy resin Proprietary 0.0336  +S -S Phenol resin Proprietary 0.0336  +S -S Carbon Black 1333-86-4 0.0056  +C -C Supplier +S -S Palladium compound Proprietary 0  +S -S Palladium compound Proprietary 0  +S -S Hydroquinone 123-31-9 0  +S -S Acrylate Proprietary 0.0025  +S -S Bismaleimide resin Proprietary 0.0055	+C -C Supplier	+C -C Supplier +S -S Cu 7440-50-8 0.8247 mg	+C -C Supplier